IPC ASSOCIATION CO	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				ials and Mfg Information				
upplier Iı	nformation													
Company name*			Company unique ID			U	Unique ID Authority				Response Date*			
nsemi											2025-09-16			
Contact Nam	ne	Title - Contact			P	Phone - Contact*				Email - Contact*				
Product-Env	v-Stewards	Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com				
uthorized R	Representative*	Title - Representative			P	Phone - Representative*			Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com			
R	equester Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Date Version Manufacturing Site		Ianufacturing Site	V	Veight*	UOM	Unit Type
	FDMF2011 100V Sm		100V Smart Power	0V Smart Power Stage		2025-09-16 PBB		PBB		51.40115	mg	Each		
	uring Process Informa		'arminal Daga	Alloy	STD-020 MSL l	Pating	Dook Dwoo	oss Pody To	maratur	Max Time at Peak	Tamparati	yra Numba	r of Reflow Cyo	alac
		Terminal Base Alloy J-STD CU Alloy 1		S I D-020 MSL I	Kaung	Peak Process Body Tem 260		•	30			r of Reflow Cyc	cies	
•	atte 1111 (Sn) - annealed	C	U Alloy	1			200		C	30	second	ds 3		
omments		·		20										
	imum time at peak temperat	8												
r more info	ormation regarding materia	I composition	piease refer to	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominal contains a RoHS restricted substance inexcess encompass all such components. Supplier certi as of the date that Supplier completes this for Company acknowledges that Supplier may ha independently verified information provided by certification in this paragraph. If the Company	ted biphenyls and/or polybrominated dipheny of an applicable quantity limit, please indicate fies that it gathered the information it provident. Supplier acknowledges that Company will we relied on information provided by others in the supplier agrees that, at a minimum and the Supplier enter into a written agreements ource of the Supplier's liability and the Com-	2011/65/EU and implemented by the laws of the End ethers (each a "RoHS restricted substance") in except the below which, if any, RoHS exemption you believe in this form using appropriate methods to ensure rely on this certification in determining the compliant completing this form, and that Supplier may not have its suppliers have provided certifications regarding ent with respect to the identified part, the terms and capany's remedies for issues that arise regarding information in the provided certification in	sess of the applicable quantity limit identified able may apply. If the part is an assembly with low its accuracy and that such information is true annee of its products with European Union member ave independently verified such information. However, their contributions to the part, and those certifications of that agreement, including any warr	bove. If a homogeneous material within the part ver level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. It is involved in situations where Supplier has not ations are at least as comprehensive as the ranty rights and/or remedies provided as part of						
RoHS Declaration * 4 - Item(s	) does not contain RoHS restricted substance	s per the definition above except for selected exemp	otions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required f Requester) and click on Submit Form to ha		Accepted" on the Supplier Acceptance drop-dow	n. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	astislav Drska	-En								

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	42.0022	mg	Supplier	Zinc (Zn)	7440-66-6		0.0504	mg
			Supplier	Iron (Fe)	7439-89-6		1.0081	mg
			Supplier	Copper (Cu)	7440-50-8		40.9101	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0336	mg
Clip Attach	0.2	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		0.015	mg
			Supplier	Proprietary	Proprietary Data		0.013	mg
			Supplier	Bismaleimide	13676-54-5		0.056	mg
			Supplier	PTFE	9002-84-0		0.116	mg
Die	5.4	mg	Supplier	Silicon (Si)	7440-21-3		5.4	mg
Die Attach Solder	7.60012	mg	Supplier	Silver (Ag)	7440-22-4		0.19	mg
			A	Lead (Pb)	7439-92-1	7a	7.0301	mg
			Supplier	Tin (Sn)	7440-31-5		0.38	mg
Lead Frame	51.7993	mg	Supplier	Silver (Ag)	7440-22-4		2.59	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0622	mg
			Supplier	Iron (Fe)	7439-89-6		1.2432	mg
			Supplier	Copper (Cu)	7440-50-8		47.8626	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0414	mg
Mold Compound-Black	40.1995	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		2.613	mg
			Supplier	Carbon Black (C)	1333-86-4		0.201	mg
			Supplier	Silica (SiO2)	14464-46-1		35.3756	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		2.01	mg
Plating	4.1	mg	Supplier	Tin (Sn)	7440-31-5		4.1	mg
Wire Bond	0.10003	mg	Supplier	Palladium (Pd)	7440-05-3		0.0018	mg
			Supplier	Gold (Au)	7440-57-5		0.0001	mg
			Supplier	Copper (Cu)	7440-50-8		0.0981	mg